





TRAINING

- Expert Training in the Latest Technologies
- Industry-Demanded Certifications

PCB TECHNOLOGY

Quality & Inspection

■ IPC-A-610 Instructor & Operator Certification

Soldering & Assembly

IPC J-STD-001 Instructor
 & Operator Certification

Bare Board Inspection

- IPC-A-600 Instructor & Operator Certification
- IPC-6012 Instructor & Operator Certification

Rework & Repair

■ IPC-7711 & IPC-7721 Instructor & Operator Certification

Hand Soldering Skills

Soldering Basics, Wires & Terminals, Lap Solder Joints, Through-Hole and Surface Mount Training

PCB Fundamentals

- Component Identification
- Electrostatic Discharge

PCB Design

- Essentials of PCB Design
- IPC Designer Certification

COUNTERFEIT COMPONENTS

IDEA-STD-1010

- Seminars & Workshops
- IDEA-STD-1010 Essentials
- SAE AS5553
 Counterfeit Electronics

CABLE & WIRE HARNESS TECHNOLOGY

Quality & Inspection

■ IPC-A-620 Instructor & Operator Certification

Hands-On Labs

Crimping & Harness Assembly Training

TECHNICAL SUPPORT

- Manufacturing Start-Up
- Process Evaluation
- Subcontractor Qualification
- Equipment Evaluation
- Lead-Free, ESD, Process and Quality Audits

IPC PCB DESIGNER CERTIFICATION (CID)

IPC's Interconnect Designer Certification

IPC-2221 / IPC-2222 / IPC-T-50

COURSE DESCRIPTION

The IPC Designer Certification (CID) is a professional development program introducing the basics of PCB design and a better understanding between design and actual assembly of the final product. The program reviews the production process and how changes in PCB layout can reduce production problems further down the road.

This 4-day, lectured course (3-days lecture, 1-day review and testing), goes beyond the fundamentals of component placement and track routing to encompass an understanding of all the elements that go into product development utilizing IPC-2221 "Generic Standard on Printed Board Design" and IPC-2222

"Sectional Design Standard for Rigid Organic Printed Boards".

The program covers guidance and requirements for printed board assembly and design parameters from component mounting, interconnecting structures, conductor characteristics, surface finishes, board electrical test, thermal stress, panelization, laminate selection, scoring and routing parameters, board thickness tolerance, nonfunctional lands, hole aspect ratios, via hole size and printed board edge spacing just to name a few.

Taught by recognized industry professionals, this program enhances your experience by exposing you to IPC Certified Instructors who possess a broad expertise and appreciation for the process. This course is also an excellent course for anyone involved in the development, design and fabrication, at any level from sales, management, procurement, or quality in printed circuit board production.

Class materials are sent out upon enrollment. Participants are expected to be familiar with course materials prior to class.

WHO SHOULD ATTEND

This course is designed for anyone involved in the development, design and fabrication—at any level from sales, management, procurement, or quality—in printed circuit board production.

PREREQUISITES

- Completion of IPC's on-line IPC Essentials program*
- Completion of IPC's on-line Policies & Procedures program*
- Understanding of the English language, oral and written

*In order for IPC Certification to be issued, completion of these two on-line programs must be completed outside of class via IPC's website. The IPC Essentials Exam will be completed on-line at the beginning of class.

CLASS SIZE

Maximum number of students is limited to ten (10) in order to provide greater instructor interaction. Call early to reserve your space.

COURSE OUTLINE

DAY 1

DESIGN CONSIDERATIONS

- Considerations for Design
- Placement and Routing Techniques
- Electrical Characteristics
- Copper Clad Laminates
- Holes in Printed Boards
- Drilling and Hole Locations
- Features Formed in Copper

THERMAL, RELIABILTTY, AND TESTING ISSUES

- Thermal Management of Boards
- Thermal Management of Assemblies
- Reliability
- Board and Assembly Testing

ELECTRICAL PARAMETERS

- Printed Board and Assembly Viewing Principles
- Introduction to Datum Dimensioning
- Grid Systems
- Tooling Holes and Fiducials
- Board and Assembly Panelization
- Panel/Pallet Separation Methods

DAY 2

COMPONENT TYPES

- Basic Components
- Embedded Components
- Edge Board Connectors
- Stiffeners, Bus Bars, Sockets, Jumpers and Terminals, MELFs, Eyelets

COMPONENT AND ASSEMBLY ISSUES

- Parts List Development
- Printed Board Tolerance Analysis
- Documentation to Facilitate Design to Fabrication Interface
- \bullet Printed Board and Assembly Data Format Standardization
- Component Insertion & Attachment Techniques
- Solder Processes
- Clinched Leads

BOARD SURFACE TREATMENTS

- $\bullet \ \mathsf{Solder} \ \mathsf{Mask}, \ \mathsf{Conformal} \ \mathsf{Coatings}, \ \mathsf{Protective} \ \mathsf{Coatings} / \mathsf{Surface} \ \mathsf{Finishes} \\$
- Legend
- Conductive Inks

DAY 3

DOCUMENTATION AND DIMENSIONING

- Documentation and Classifications
- Basic Drawing Formats

SCHEMATIC AND LOGIC DIAGRAMS

FABRICATION AND TOLERANCING REQUIREMENTS

- Board Fabrication Documentation
- Dimensioning and Tolerancing

ASSEMBLY DOCUMENTATION AND BOMS

DAY 4

Q & A

CERTIFICATION TESTING

REGISTRATION For up to date pricing and more information on any of the EPTAC programs, or to enroll, please call us toll free or visit eptac.com.

Toll Free: 1-800-64-EPTAC **email:** register@eptac.com **Web:** eptac.com

ON-SITE TRAINING Please call a training consultant and ask about customized course content, on-site training and training around your production schedules.